

KIOXIA CM9-V Series (2.5-inch)

(KCM9XVUL/KCM9DVUL/KCM9FVUL) Enterprise NVMe™ Mixed Use SSD

KIOXIA CM9-V Series is a mixed use SSD that is optimized to support a broad range of enterprise applications and associated workloads. Built on PCIe[®] 5.0 and NVMe[™] 2.0 technology, the CM9 Series SSDs deliver excellent performance up to 3,400K IOPS (random read) and 800K IOPS (random write).

CM9-V 2.5-inch form factor SSDs deliver 3 DWPD (Drive Writes Per Day) of endurance, making them ideally suited for read intensive enterprise applications, featuring KIOXIA BiCS FLASH™ 3D TLC flash memory generation 5 (for 1.6 TB and 3.2 TB models) and generation 8 (for 6.4 TB and 12.8 TB models).



Product image may represent a design model.

Key Features

- PCle® 5.0, NVMe[™] 2.0 specification compliant
- Open Compute Project Datacenter NVMe[™] SSD specification v2.5 support (not all requirements)
- · Form factor: 2.5-inch, 15 mm thickness
- Proprietary KIOXIA architecture: controller, firmware and BiCS FLASH™ 3D TLC flash memory generation 5 and generation 8
- SFF-TA-1001 conformant (U.3)
- Dual-port design optimized for high availability applications
- High performance with lower power consumption
- Power Loss Protection (PLP) and End-to-End Data Protection
- Suited for 24x7 enterprise workloads
- Security options: SIE, SED, FIPS SED [1][2][3][4][5]

Key Applications

- · Artificial intelligence and machine learning
- Business intelligence
- · Data warehousing
- Online transaction processing (OLTP) (transactional and relational databases)
- Software defined storage and virtualization

Specifications (for U.2 hosts)

SIE Model Number	KCM9XVUL12T8	KCM9XVUL6T40	KCM9XVUL3T20	KCM9XVUL1T60		
SED Model Number	KCM9DVUL12T8	KCM9DVUL6T40	KCM9DVUL3T20	KCM9DVUL1T60		
FIPS SED Model Number	KCM9FVUL12T8	KCM9FVUL6T40	KCM9FVUL3T20	KCM9FVUL1T60		
Capacity	12,800 GB	6,400 GB	3,200 GB	1,600 GB		
Basic Specifications						
Form Factor	2.5-inch, 15 mm thickness					
Interface	PCIe [®] 5.0, NVMe [™] 2.0					
Maximum Interface Speed	128 GT/s (PCle® Gen5 single x4, dual x2)					
Flash Memory Type	BiCS FLASH™ TLC					

Specifications (Continued)

Capacity	12,800 GB	6,400 GB	3,200 GB	1,600 GB			
Performance in single port (1x4) mode (Up to)							
Sustained 128 KiB Sequential Read	14,800 MB/s		14,500 MB/s				
Sustained 128 KiB Sequential Write	11,000 MB/s	10,000 MB/s	7,000 MB/s	3,600 MB/s			
Sustained 4 KiB Random Read	3,400K IOPS		2,900K IOPS	2,050K IOPS			
Sustained 4 KiB Random Write	800K IOPS		600K IOPS	310K IOPS			
Power Requirements							
Supply Voltage	12 V ± 10 %, 3.3 V ± 15 %						
Power Consumption (Active)	25W typ.						
Power Consumption (Ready)	5W typ.						
Reliability							
MTTF	2,500,000 hours						
Warranty	5 years						
DWPD	3						
Dimensions							
Thickness	15.0 mm +0 / -0.5 mm						
Width	69.85 mm ± 0.25 mm						
Length	100.45 mm Max						
Weight	130 g Max						
Environmental							
Temperature (Operating)	0 °C to 75 °C						
Temperature (Non-operating)	-40 °C to 85 °C						
Humidity (Operating)	5 % to 95 % R.H.						
Vibration (Operating)	21.27 m/s² { 2.17 Grms } (5 to 800 Hz)						
Shock (Operating)	9.8 km/s² { 1,000 G } (0.5 ms)						

Definition of capacity: Kioxia Corporation defines a megabyte (MB) as 1,000,000 bytes, a gigabyte (GB) as 1,000,000,000 bytes and a terabyte (TB) as 1,000,000,000,000 bytes. A computer operating system, however, reports storage capacity using powers of 2 for the definition of 1GB = 2°30 = 1,073,741,824 bytes and 1TB = 2°40 bytes = 1,099,511,627,776 bytes and therefore shows less storage capacity. Available storage capacity (including examples of various media files) will vary based on file size, formatting, settings, software and operating system, and/or pre-installed software applications, or media content. Actual formatted capacity may vary.

GT/s: Giga Transfers per second.

A kibibyte (KiB) means 2^10, or 1,024 bytes.

MTTF (Mean Time to Failure) is not a guarantee or estimate of product life; it is a statistical value related to mean failure rates for a large number of products which may not accurately reflect actual operation. Actual operation life of the product may be different from the MTTF.

DWPD: Drive Writes Per Day. One full drive write per day means the drive can be written and re-written to full capacity once a day every day under the specified workload for the specified lifetime. Actual results may vary due to system configuration, usage and other factors.

Read and write speed may vary depending on various factors such as host devices, software (drivers, OS etc.), and read/write conditions.

IOPS: Input Output Per Second (or the number of I/O operations per second).

Temperature (operating): Specified by the composite temperature reported by SMART.

- [1] Sanitize Instant Erase (SIE), Self-Encrypting Drive (SED) and FIPS (Federal Information Processing Standards) SED security optional models are available.
- [2] SIE optional model supports Cryptographic Erase, which is a standardized feature defined by the technical committees (SCSI) of INCITS (the InterNational Committee for Information Technology Standards).
- [3] SED optional model supports TCG Opal and Ruby SSCs. It has a few unsupported features of TCG Opal SSC. For more details, please make inquiries through "Contact us" in each region's website, https://www.kioxia.com/.
- [4] FIPS SED optional model utilizes a security module designed to comply with FIPS 140-3, which defines security requirements for cryptographic module by NIST (National Institute of Standards and Technology). For the latest validation status, please make inquiries through "Contact us" in each region's website, https://www.kioxia.com/.
- [5] Security optional models are not available in all countries due to export and local regulations.

All information provided here is subject to change without prior notice.

PCIe is a registered trademark of PCI-SIG.

 ${\sf NVMe}\ is\ a\ registered\ or\ unregistered\ mark\ of\ NVM\ Express, Inc.\ in\ the\ United\ States\ and\ other\ countries.$

Other company names, product names, and service names may be trademarks of third-party companies.